Hungary/Romania Section EP21/NANO42 Jt. Chapter

Kick-off meeting

Attila Bonyár Chapter Chair

Thursday, 13. February, 2020 *Timisoara*



IEEE HU&RO EPS&NTC JOINT CHAPTER



Chapter History



- The IEEE Joint Hu/Ro EPS Chapter was established in 1999 by Zsolt Illyefalvi-Vitéz and Paul Svasta (20-year anniversary in 2019)
- Past Chapter Chairs
 - Zsolt Illyefalvi-Vitéz (1999-2001)
 - Paul Svasta (2001-2005)
 - Dan Pitica (2005-2012)
 - Ciprian Ionescu (2012-2019)



- The Chapter is active in many regular events
- The fundamental, traditional characteristic of the Chapter is the strong connection and cooperation between members, both on a professional and personal level.



2019.10.24. Cluj-Napoca: Elected officers for the next term



- Chapter Chair: Attila Bonyár
- Vice Chair: Norocel Codreanu
- Secretary: Radu Bozomitu
- Junior Past Chair: Ciprian Ionescu
- Senior Past Chair: Paul Svasta
- Senior Past Chair: Dan Pitica













Prof. Illyefalvi-Vitéz IEEE Excellence Award

Congratulations!

IEEE Hungary Section Excellence Award

is hereby granted to

Prof. Zsolt Illyefalvi-Vitéz

honoring his outstanding contributions to the components, packaging and manufacturing technology.

Budapest, January 7, 2020



Kovais Levente

ection Chair, IEEE HS

- amh Krisztián Lamár Awards & Recognition Chair, IEEE HS



Why join forces with NTC?

- The idea was first originated by Jim Morris and Paul Svasta, who saw potential benefits in the union of chapters.
- In the past two decades nanotechnology and nanomaterials made their way into different areas of electronics packaging and electronics technology in general.
- Traditional conferences and seminars related to electronics technology and packaging have their own "nano-tracks" for some time now.
- Romania and Hungary both have academic experts in research institutions and also industrial companies (mostly on the SME) level related to both areas (EPS&NTC).





2019.12.06. The proposed merging with NTC was accepted



Cecelia Jankowski Managing Director Member and Geographic Activities Phone +1 732 562 5504 Fax +1 732 867 9943 cjankowski@ieee.org

December 6, 2019

Attila Bonyar BUTE, Dep. of Electronics Technology Egry Jozsef Street 18 V1 Building 009 Budapest, Pest 1111 Hungary

Dear Attila Bonyar:

Congratulations! On behalf of the IEEE Member and Geographic Activities Vice President, Francis Grosz, and IEEE Technical Activities Vice President, Ray Liu, it is a pleasure to inform you that the requirements of the MGA Board Operations Manual have been met, and the Nanotechnology Council has been added to the existing IEEE Hungary and Romania Joint Sections Electronics Packaging Society Chapter. The effective date of this chapter formation is December 5, 2019.

You have been recorded as the Chapter Chair. When an election has been held, please report the name and member number of the new Chapter Chair to the IEEE using the online officer reporting tool at https://officers.vtools.ieee.org/. Valuable information regarding IEEE Society Chapters can be found at http://www.ieee.org/societies_communities/geo_activities/chapters. If we can assist you in any way in the planning of the chapter activities, please let us know.

We extend our best wishes for the successful operation of this chapter.

Sincerely,

Cerelia Jankowski

Cecelia Jankowski Managing Director Member and Geographic Activities

- cc: F. Grosz Member and Geographic Activities Vice President R. Liu – Technical Activities Vice President
 - M. Salazar-Palma Region 8 Director
 - A. Bar-Cohen Electronics Packaging Society President
 - D. Manning Electronics Packaging Society Executive Director
 - K. Pearsall Electronics Packaging Society Chapter Programs
 - Y. Tzeng Nanotechnology Council President
 - N. Massetti Nanotechnology Council Chapters
 - L. Kovacs Hungary Section Chair
 - C. Negrescu Romania Section Chair
 - M. Ward-Callan Technical Activities Managing Director



IEEE HU&RO EPS&NTC JOINT CHAPTER



IEEE NTC Chapters Worldwide



IEEE NTC Chapters – Region 8



IEEE EPS Chapters Worldwide

Student Branch – 14 Chapter – 16 Joint Chapter – 19 SUM – 49

Gaze



IEEE EPS Chapters – Region 8



Our joint chapter in numbers

Region	Council	Section	Grade Category	Grade	Total			
R8	Region 8 - No Council	Hungary Section	IEEE Grades	Associate Member	1	*		
				Graduate Student Member	2			
				Life Member	1			
				Member	12		Count by Gender	
				Senior Member	1		Unknown	Female Male
				Student Member	1	=	6.52% Fema	ile 📃 Unknown
			Total		18		25.0	0%
		Romania Section	IEEE Grades Other Grades	Graduate Student Member	14			
				Life Senior	2			
				Member	39			
				Senior Member	5		Male	
				Student Member	13		68.48%	
				Affiliate	1			
			Total		74	-		
Grand 1	Total				92			

Count by Region and Grade

Before merging with the NTC we had **5 (Hu) + 26 (Ro)** = 31 members.

Now we have 18 (Hu) + 74 (Ro) = 92 members.

This is a **x3** increase in total number of members.

(Not including 4 new Hungarian members.)



Joining the IEEE NTC – Step 1

Create account at https://ieee.org/ (free)



Joining the IEEE NTC – Step 2

https://ieeenano.org/



Joining the IEEE NTC – Step 3

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Memberships and Subscriptions Cata	Browse -		
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The IEEE Nanotechnology Council focuses on the advancement and coordination of work in the field of Nanotechnology. The Council is a multi-disciplinary group supporting the theory, design, and development of nanotechnology and its scientific, engineering, and industrial applications. The Council sponsors well-recognized, international conferences and publications, including: > IEEE Transactions on Nanotechnology > IEEE Transactions on Nanotechnology > IEEE Nanotechnology Magazine > International Conference on Nanotechnology (NANO) > IEEE Nanotechnology Materials and Devices Conference (NMDC) > IEEE International Conference on Nano/Micro Engineered and Molecular Systems (NEMS) IEEE International Conference on Nano/Molecular Medicine and Engineering (NANOMED)	 IEEE Nanotechnology Council Sign in to see your price IEEE Member Prices ? IEEE member IEEE Student member Sponsoring society member Sponsoring society student member Non-IEEE member ? Join IEEE ? Join a Society sponsoring this product (US\$0.00 US\$0.00 US\$0.00 US\$0.00 US\$0.00	
Through the Council's sponsored activities, participants have the opportunity to publish and collaborate on research, network with colleagues, stay current on news and events, develop standards, and participate in educational activities.	Ado	i item(s)	IEI

Chapter mailing list and website

- An IEEE mailing list was established on the IEEE LISTSERV
- Name of the list: <u>huro-epsntc@listserv.ieee.org</u>
 - Adding IEEE (EPS/NTC) members (all 92)
 - Add other non IEEE members as well?
- IEEE provides domains for chapters as well
- I will apply for the <u>site.ieee.org/huro-epsntc</u> site.
- There are two types of templates to choose from
 - Section template (official) modern
 - Comm. Soc. Template classic look



Website template – modern

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		DATE NAME May 21, New paradigms for IC: Can Unpaved Roads Become	LOCATION ORGANIZER BUCHAREST, IEEE SSCS Romania ROMANIA	1	DESCRIPTION Speaker: Sorin Cotofana (Netherlands)	♦ STATUS ♦ CLOSED

Chapter Annual Event Clock







THE SPRING CONVENTION OF ELECTRONIC PACKAGING COMMUNITY THE 29th EDITION, BUCUREȘTI, 1st-4th APRIL 2020





IEEE - ISSE

43rd International Spring Seminar on Electronics Technology

Trends in Microelectronics Packaging and Interconnection Technology

May 13 – **17, 2020**

Demanovska Valley - Slovakia, Hotel Grand Jasna

Chapter involvement:

Joint keynote presentation regarding the **establishment of the Hu&Ro EPS&NTC chapter** and more generally about the **connections between electronics packaging and nanotechnology**.





Presenters:

Jim Morris (NTC President)

Attila Bonyár (Chapter Chair)



1st Hungarian NTC Workshop

- The aim of the Workshop would be to connect and organize Hungarian academic institutions working on the field of nanotechnology, primarily to facilitate national and regional cooperation.
- The 1st workshop would be national to clearly define the goals of this part of the chapter. The event would be raised to an international level from the second year.
- Already a large number of institutions/researchers reacted very positively to this initiative.



IEEE – ESTC: R8 "flagship" of EPS

- Since 2006 ESTC has been organized biannually by a different hosting institution in different parts of Europe
- ESTCs in the past:
 - 2006, Dresden, Germany
 - 2008, Greenwich, the UK
 - 2010, Berlin, Germany
 - 2012, Amsterdam, the Netherlands
 - 2014, Helsinki, Finland
 - 2016, Grenoble, France
 - 2018, Dresden, Germany
- Upcoming editions:
 - 2020, Vestfold, Norway
 - 🛑 2022, Sibiu, Romania
 - 2024, tbc







lapter involvement





IEEE – SIITME: "flagship" of our Chapter







IEEE – SIITME: "flagship" of our Chapter

IEEE 26th International Symposium for Design and Technology in Electronic Packaging, 21st - 24th of October, Pitești, Romania

SIITME 2020

TOPIC S

- A. Emerging Topics in Advanced Packaging;
- B. New Components and Manufacturing Technologies;
- C. Printed Electronics, Smart Textiles and Healthcare;
- D. Sensors, Actuators and Microsystems;
- E. Nanomaterials, Nanoelectronics and Nanotechnology;
- F. Embedded Systems, Robotics and Artificial Intelligence;
- G. Power Electronics and Thermal Management;
- H. Smart Grid and Renewable Energy;
- I. Virtual Prototyping and System Validation;
- J. Quality Management, Applied Reliability, Characterization and Testing Failure Diagnosis;
- K. Challenges in Global Education for Electronics.
- Since last year SIITME has a "nano-track".
- Papers are published on IEEE Explore.



DLC and invited lecturer options for SIITME

- Primarily considering the promotion of nanotechnology
- 2020 list is not yet available (expected to be released in February).
- IEEE Nanotechnology Council (NTC) Distinguished Lectures for 2019
- (From: <u>https://ieeenano.org/dl-program/distinguished-lecturers-2019/</u>)
- Dominique Baillargeat, University of Limoges, France
- Distinguished Lecturer Talk Title: 3D Radio-Frequency to millimeter wave heterogeneous system integration: Emerging nanotechnology for RF nanopackaging, the link between nanoscopic and macroscopic worlds?
- **Xiaoning Jiang,** North Carolina State University, Raleigh, NC USA
- Distinguished Lecturer Talk Title: Nanoacoustics: Materials, Devices and Applications



DLC and invited lecturer options for SIITME

- Chenzhong Li, National Science Foundation, Alexandria, VA, USA
- Distinguished Lecturer Talk Title(s):
- Biomedical Devices for Nano-Theranostics
- Bioelectronic and Biosensors-From Cell on a Chip to Point of Care Testings
- NanoBiosensing Research-Challenges, Opportunities, and Perspectives From USA National Science Foundations
- Prof. Ved Ram Singh, National Physical Laboratory (NPL), New Delhi, India
- Distinguished Lecturer Talk Title(s):
- 1: Nano-sensor technology with IoT
- 2: Advanced nanosensors and systems for u-health care
- 3: Nano-Cancer Technology: New Diagnostic and Therapeutic Devices



DLC and invited lecturer options for SIITME

- IEEE Electronics Packaging Society
- (From: <u>https://eps.ieee.org/education/distinguished-lecturer-program.html</u>)
- Mervi Paulasto-Kröckel, Ph.D., Aalto University, Helsinki, Finland
- Topics: MEMS, electronics reliability, automotive components and packaging, implantable electronics, dissimilar materials & interfaces



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HUNGARY/ROMANIA SECTION JT. CHAPTER EP21/NANO42, CHAPTER KICK-OFF MEETING

On the 6th of December 2019 the IEEE directors approved our petition to add the Nanotechnology

Agenda

9:00-11:00: morning program at Continental Automotive Timisoara

11:00-11:30: refreshments (lunch break), gathering, informal discussion etc.

11:30-15:00: main session:

- Opening of the meeting: Attila Bonyár, chapter chair.
- Welcome speech: Cristian Negrescu, Romania Section chair
- Welcome speech: Levente Kovács, Hungary Section char
- Report on the EPS&NTC merging, plans for the future: Attila Bonyár, chapter chair
- Short Technical presentations on nanotechnology applications in electronics:
- ->Traian Cornel Cucu, Alpha Assembly Solutions, USA: "Next Generation Assembly Challenges".
- ->Carmen Moldovan, IMT-Bucharest, Romania: "Nanotechnology for sensors and energy harvesting solutions".
- ->Péter Petrik, HAS Centre for Energy Research Photonics Department, Hungary: "Development of non-destructive material characterization methods".

15:00-16:00: Visit at the R&D (reliability) of Continental Automotive Timisoara.





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Plans for the joint EPS&NTC chapter

- Expanding the Hu&Ro Chapter with Nanotechnology related academic experts and industrial members.
- Invite new members to join the IEEE and EPS / NTC. (No IEEE membership is required to join the NTC).
 - Cooperation with the recently established Romanian NTC Chapter.
 - Invite Romanian industrial members related to Nanotechnology.
 - Invite Hungarian academic/industrial members. Organize NTC in Hungary.
- Expand the topics of existing professional events with nanotechnology (where applicable). Organize new, yearly workshops related to NTC in Hungary and in Romania.



Thank You for Attending

IEEE Hu&Ro EPS&NTC Chapter Meeting 13.02.2020

